

## QUICKSWITCH<sup>®</sup> PRODUCTS HIGH-SPEED CMOS QUICKSWITCH 16-BIT LOW RESISTANCE MULTIWIDTH<sup>™</sup> BUS SWITCH

### FEATURES:

- Enhanced N channel FET with no inherent diode to Vcc
- 2.5Ω bidirectional switches connect inputs to outputs
- Zero propagation delay, zero ground bounce
- QS32XR245 is a 16-bit version of QS3R245
- Flow-through pinout for easy layout
- Undershoot clamp diodes on all switch and control inputs
- TTL-compatible control inputs
- Available in 40-pin QVSOP Package

## APPLICATIONS

- Low resistance applications
- Hot-swapping and hot-docking (low resistance for PCI and Compact PCI applications)
- Bus switching and isolation
- Voltage translation (5V to 3.3V)
- Capacitance reduction and isolation
- Power conservation
- Logic replacement (data processing)
- Clock gating

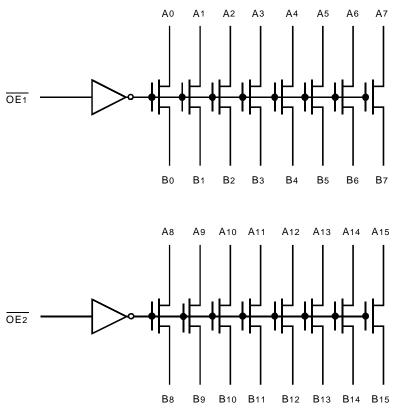
# FUNCTIONAL BLOCK DIAGRAM

#### **DESCRIPTION:**

The QS32XR245 is a member of the MultiWidth<sup>TM</sup> family of QuickSwitch devices and provides a set of 32 high-speed low resistance CMOS compatible bus switches in a flow-thru pinout. This device is available in the MillipaQ package, the world's first small outline 16-bit solution. The low onresistance of the QS32XR245 allows inputs to be connected to outputs without adding propagation delay and without generating additional ground bounce noise. When Output Enable ( $\overline{OEn}$ ) is low, the switches are turned on, connecting bus A to bus B. When  $\overline{OEn}$  is high, the switches are turned off. This device is ideally suited for 16/32 bit applications where board space is at a premium. The low resistance of QS32XR245 makes it ideal for PCI hot docking application.

QuickSwitch devices provide an order of magnitude faster speed than conventional logic devices.

The QS32XR245 is characterized for operation at -40°C to +85°C.

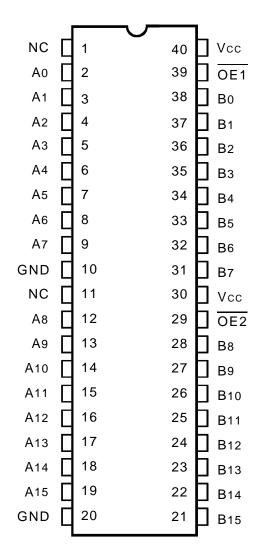


1

#### INDUSTRIAL TEMPERATURE RANGE

#### **NOVEMBER 1999**

#### **PIN CONFIGURATION**



QVSOP TOP VIEW

## ABSOLUTE MAXIMUM RATINGS (1)

Symbol	nbol Description		Unit
VTERM <sup>(2)</sup>	Supply Voltage to Ground - 0.5 to +7		V
VTERM <sup>(3)</sup>	DC Switch Voltage Vs	– 0.5 to +7	V
VTERM <sup>(3)</sup>	DC Input Voltage VIN	– 0.5 to +7	V
VAC	AC Input Voltage (pulse width ≤20ns)	-3	V
Ιουτ	DC Output Current	120	mA
Рмах	Maximum Power Dissipation	.92	W
Tstg	Storage Temperature	- 65 to +150	°C

#### NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc Terminals.

3. All terminals except Vcc.

## CAPACITANCE

 $(TA = +25^{\circ}C, f = 1.0MHz, VIN = 0V, VOUT = 0V)$ 

Pins	Тур.	Max. <sup>(1)</sup>	Unit
Control Inputs	3	4	pF
Quickswitch Channels (Switch OFF)	5	6	pF

NOTE:

1. This parameter is guaranteed but not production tested.

#### **PIN DESCRIPTION**

Pin Names	I/O	Description
OE1, OE2	I	Output Enable
An	I/O	Bus A
Bn	I/O	Bus B

#### **FUNCTION TABLE(1)**

OE1	OE <sub>2</sub>	A0 - A7	A8 - A15	Function
Н	Н	Hi-Z	Hi-Z	Disconnect
L	Н	B0 - B7	Hi-Z	Connect
Н	L	Hi-Z	B8 - B15	Connect
L	L	B0 - B7	B8 - B15	Connect

#### NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

Z = High-Impedence

# DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40°C to +85°C, Vcc =  $5.0V \pm 10\%$ 

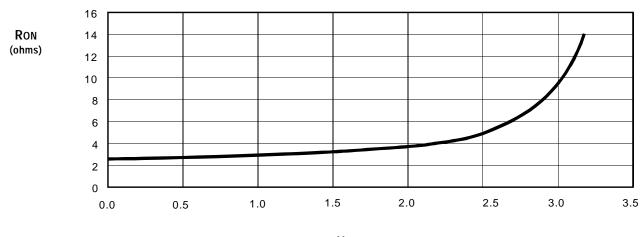
Symbol	Parameter	Test Conditions	Min.	Typ. <sup>(1)</sup>	Max.	Unit
Vih	Input HIGH Voltage	Guaranteed Logic HIGH for Control Pins	2	—		V
VIL	Input LOW Voltage	Guaranteed Logic LOW for Control Pins	_	—	0.8	V
lin	Input Leakage Current (Control Inputs)	$0V \le V_{IN} \le V_{CC}$	_	_	±1	μA
loz	Off-State Current (Hi-Z)	$0V \le VOUT \le Vcc$ , Switches OFF	_	_	±1	μA
Ron	Switch ON Resistance	Vcc = Min., VIN = 0V, ION = 30mA	_	2.5	5	Ω
Ron	Switch ON Resistance	Vcc = Min., VIN = 2.4V, ION = 15mA	_	4	8.5	Ω
Vp	Pass Voltage <sup>(2)</sup>	$VIN = Vcc = 5V$ , $IOUT = -5\mu A$	3.7	4	4.3	V

NOTES:

1. Typical values are at Vcc = 5.0V, TA =  $25^{\circ}C$ .

2. Pass voltage is guaranteed but not production tested.

## TYPICAL ON RESISTANCE vs Vin AT Vcc = 5V



VIN (Volts)

## **POWER SUPPLY CHARACTERISTICS**

Symbol	Parameter	Test Conditions <sup>(1)</sup>	Max.	Unit
Icco	Quiescent Power Supply Current	Vcc = Max., VIN = GND or Vcc, f = 0	6	μΑ
Δlcc	Power Supply Current per Control Input HIGH <sup>(2)</sup>	Vcc = Max., V <sub>IN</sub> = 3.4V, f = 0	2.5	mA
ICCD	Dynamic Power Supply Current per MHz (3)	Vcc = Max., A and B pins open	0.25	mA/MHz
		Control Input Toggling at 50% Duty Cycle		

#### NOTES:

1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.

2. Per TLL driven input (VIN = 3.4V, control inputs only). A and B pins do not contribute to  $\Delta$ Icc.

3. This current applies to the control inputs only and represents the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is guaranteed but not production tested.

# SWITCHING CHARACTERISTICS OVER OPERATING RANGE

#### $Ta = -40^{\circ}C \text{ to } +85^{\circ}C, Vcc = 5.0V \pm 10\%$

CLOAD = 50pF, RLOAD =  $500\Omega$  unless otherwise noted.

Symbol	Parameter	Min. <sup>(1)</sup>	Тур.	Max.	Unit
<b>t</b> PLH	Data Propagation Delay <sup>(2,3)</sup>		_	0.12	
<b>t</b> PHL	An to Bn, Bn to An	_	_	0.12	ns
tрzн	Switch Turn-on Delay	0.5		Γ /	
tPZL	OE to An/Bn	0.5	_	5.6	ns
tрнz	Switch Turn-off Delay <sup>(2)</sup>	0.5		4.5	
<b>t</b> PLZ	OE to An/Bn	0.5	—	4.0	ns

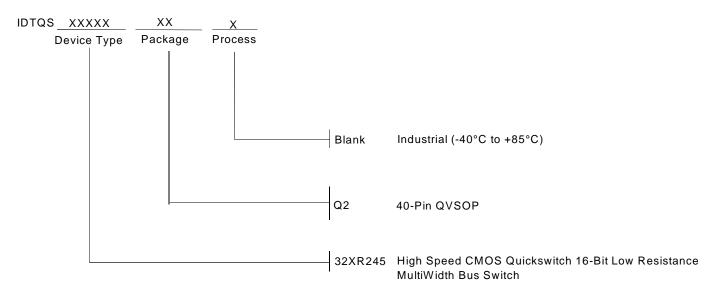
NOTES:

1. Minimums are guaranteed but not production tested.

2. This parameter is guaranteed but not production tested.

3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.12ns for CL = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

### **ORDERING INFORMATION**





*CORPORATE HEADQUARTERS* 2975 Stender Way Santa Clara, CA 95054 for SALES: 800-345-7015 or 408-727-6116 fax: 408-492-8674 www.idt.com\*

\*To search for sales office near you, please click the sales button found on our home page or dial the 800# above and press 2. The IDT logo, QuickSwitch, and SynchroSwitch are registered trademarks of Integrated Device Technology, Inc.